

TOSHIBA GTR MODULE SILICON N CHANNEL IGBT

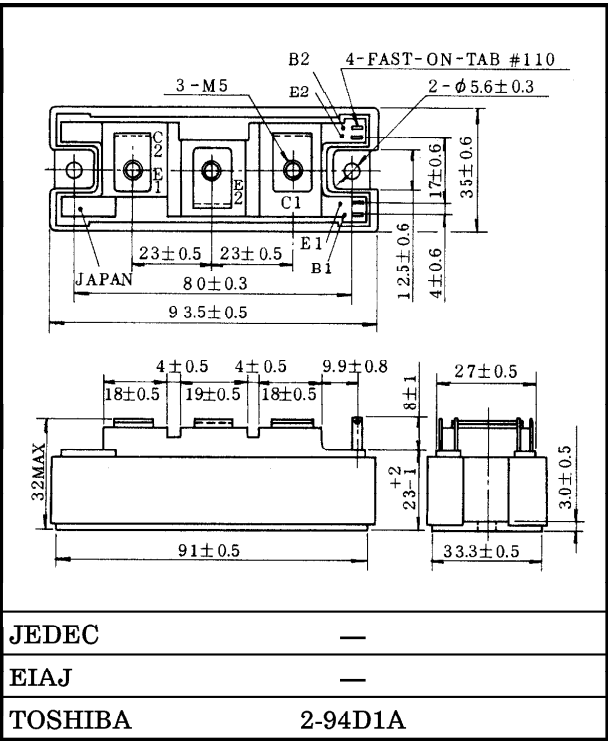
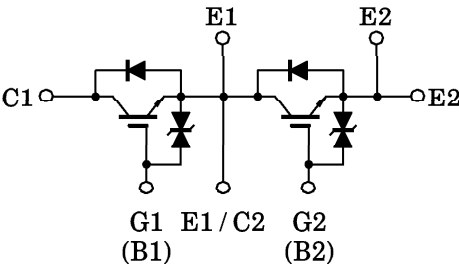
MG25Q2YS40

HIGH POWER SWITCHING APPLICATIONS.
MOTOR CONTROL APPLICATIONS.

Unit in mm

- High Input Impedance
- High Speed : $t_f=0.5\mu s$ (Max.)
 $t_{rr}=0.5\mu s$ (Max.)
- Low Saturation Voltage
: $V_{CE(sat)}=4.0V$ (Max.)
- Enhancement-Mode
- Includes a Complete Half Bridge in One Package.
- The Electrodes are Isolated from Case.

EQUIVALENT CIRCUIT



JEDEC	—
EIAJ	—
TOSHIBA	2-94D1A

Weight : 202g

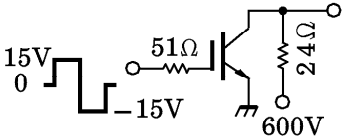
MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Collector-Emitter Voltage		V_{CES}	1200	V
Gate-Emitter Voltage		V_{GES}	± 20	V
Collector Current	DC	I_C	25	A
	1ms	I_{CP}	50	
Forward Current	DC	I_F	25	A
	1ms	I_{FM}	50	
Collector Power Dissipation (Tc = 25°C)		P_C	250	W
Junction Temperature		T_j	150	°C
Storage Temperature Range		T_{stg}	− 40 ~ 125	°C
Isolation Voltage		V_{Isol}	2500 (AC 1 minute)	V
Screw Torque (Terminal / Mounting)		—	3 / 3	N · m

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ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		I_{GES}	$V_{GE} = \pm 20V, V_{CE} = 0$	—	—	± 10	μA
Collector Cut-off Current		I_{CES}	$V_{CE} = 1200V, V_{GE} = 0$	—	—	1.0	mA
Gate-Emitter Cut-off Voltage		$V_{GE(OFF)}$	$I_C = 25mA, V_{CE} = 5V$	3.0	—	6.0	V
Collector-Emitter Saturation Voltage		$V_{CE(sat)}$	$I_C = 25A, V_{GE} = 15V$	—	3.0	4.0	V
Input Capacitance		C_{ies}	$V_{CE} = 10V, V_{GE} = 0, f = 1MHz$	—	3000	—	pF
Switching Time	Rise Time	t_r		—	0.3	0.6	μs
	Turn-on Time	t_{on}		—	0.4	0.8	
	Fall Time	t_f		—	0.2	0.5	
	Turn-off Time	t_{off}		—	0.8	1.5	
Forward Voltage		V_F	$I_F = 25A, V_{GE} = 0$	—	2.0	2.5	V
Reverse Recovery Time		t_{rr}	$I_F = 25A, V_{GE} = -10V$ $di/dt = 100A/\mu s$	—	0.2	0.5	μs
Thermal Resistance		$R_{th(j-c)}$	Transistor	—	—	0.5	$^{\circ}C/W$
			Diode	—	—	1.3	

